Docket No.: GR 97 P 1903

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor

Hansjörg Reichert et al.

Applic. KO

9/483,737

Filed

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Title

Method and Apparatus for Producing a Chip-Substrate

€onnection

Examine Ahmed N Sefer

Art Unit: 2826

RESPONSE

Hon. Commissioner of Patents and Trademarks, Washington, D. C. 20231

Sir:

Responsive to the Office Action dated September 18, 2001, the following remarks are made:

In deference to the restriction requirement on pages 2 and 3 of the above-identified Office Action, applicants elect group I, claims 11-16, for prosecution at this time.

Applicants reserve the right to file a divisional application including the method claims of group II at a later date and/or to request a rejoinder under MPEP §821.04.

In view of the foregoing, the early issuance of an Action on the merits of claims 11-16 is solicited.

Respectfully submitted.

MARKUS NOLFF REG. NO. 37,006

Date: September 26, 2001

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